CHENMKO ENTERPRISE CO.,LTD

CHBD3004BRMGP

Halogens free devices

SURFACE MOUNT
SWITCHING DIODE

VOLTAGE 350 Volts CURRENT 225 mAmpere

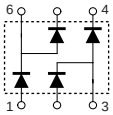
APPLICATION
* Ultra high speed switching

FEATURE
* Small surface mounting type. (SC-74/SOT-457)
* High speed. (T_{RR}=50 nSec Typ.)
* Suitable for high packing density.
* Maximum total power disspation is 350mW.
* Peak forward current is 625mA.
* High voltage capability.

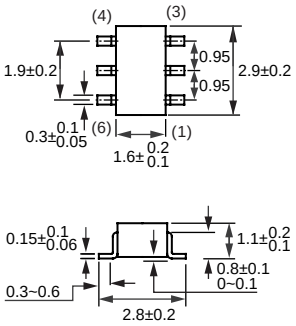
CONSTRUCTION
* Silicon epitaxial planar

MARKING
* D6P

CIRCUIT



SC-74/SOT-457



Dimensions in millimeters

SC-74/SOT-457

MAXIMUM RATINGES (At T_A = 25°C unless otherwise noted)

RATINGS		SYMBOL	CHBD3004BRMGP	UNITS
Maximum Recurrent Peak Reverse Voltage		V_{RRM}	350	Volts
Maximum RMS Voltage		V_{RMS}	300	Volts
Maximum DC Blocking Voltage		V_{DC}	212	Volts
Maximum Average Forward Rectified Current		I_O	225	mAmps
Peak Forward Surge Current	@T_P= 1uSec	I_{FSM}	4.0	Amps
	@T_P= 1Sec		1.0	
Typical Junction Capacitance between Terminal (Note 1)		C_J	5.0	pF
Maximum Reverse Recovery Time (Note 2)		T_{RR}	50	nSec
Typical Thermal Resistance		$R_{\theta JA}$	357	°C/W
Operation and Storage Temperature Range		T_J,T_{STG}	-65 to +150	°C

ELECTRICAL CHARACTERISTICS (At T_A = 25°C unless otherwise noted)

CHARACTERISTICS		SYMBOL	CHBD3004BRMGP	UNITS
Reverse Breakdown Voltage at I_R= 150uA		BV_R	350 Min.	Volts
Maximum Instantaneous Forward Voltage at I_F= 100mA		V_F	1.0	Volts
Maximum Average Reverse Current at V_R= 240V	@T_A= 25°C	I_R	100	nAmps
	@T_A= 150°C		100	uAmps

NOTES : 1. Measured at 1.0 MHz and applied reverse voltage of 0 volts.
2. Measured at applied froward current of 30mA ,reverse current of 30mA ,R_L=100 Ω and recovery to I_{RR}=3mA.
3. ESD sensitive product handling required.

2004-09

RATING CHARACTERISTIC CURVES (CHBD3004BRMGP)

Typical Electrical Characteristics

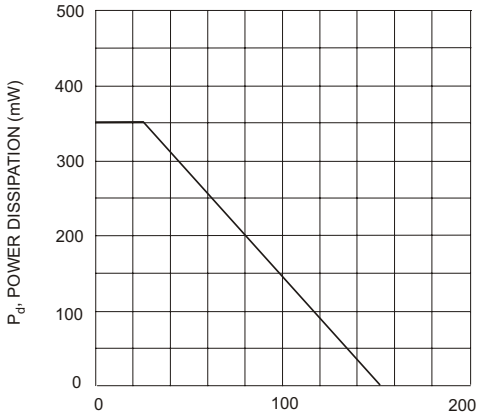


Fig. 1 Power Derating Curve, total package

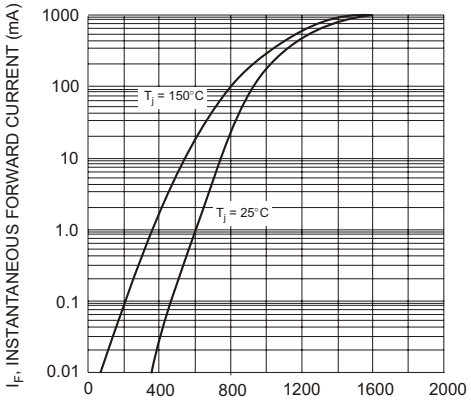


Fig. 2 Typical Forward Characteristics, per element

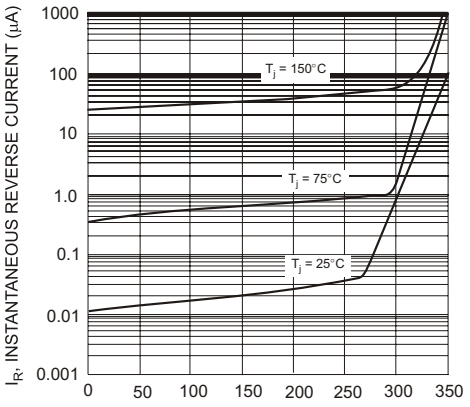


Fig. 3 Typical Reverse Characteristics, per element

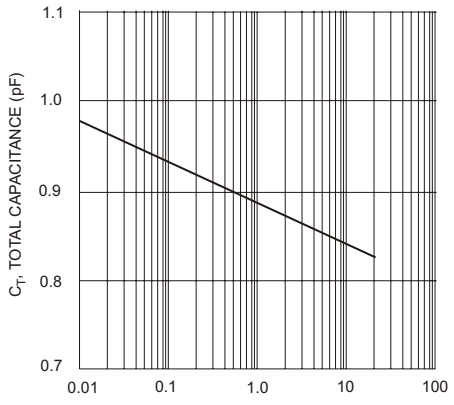


Fig. 4 Typical Total Capacitance
vs. Reverse Voltage, per element